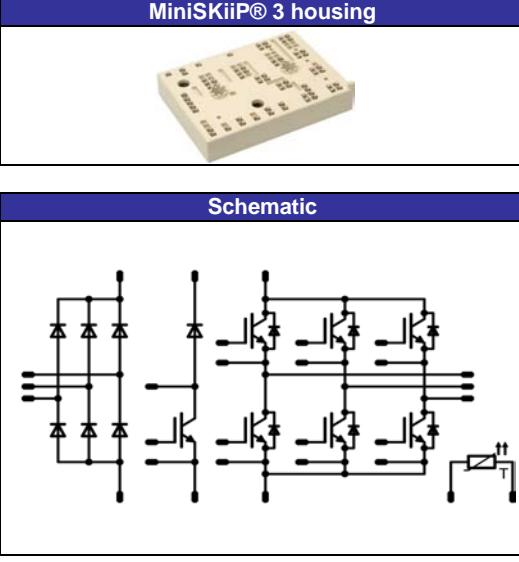


MiniSKiiP® 3 PIM		1200V / 75A
<b>Features</b>	• Solderless interconnection • Trench Fieldstop IGBT4 technology	<b>MiniSKiiP® 3 housing</b>
<b>Target Applications</b>	• Industrial Drives	
<b>Types</b>	• V23990-K429-A40-PM	

## Maximum Ratings

$T_j=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Input Rectifier Diode</b>				
Repetitive peak reverse voltage	$V_{RRM}$		1600	V
DC forward current	$I_{FAV}$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$	58	A
Surge forward current	$I_{FSM}$	$t_p=10\text{ms}$ $T_j=25^\circ\text{C}$	450	A
$I^2t$ -value	$I^2t$		1020	$\text{A}^2\text{s}$
Power dissipation per Diode	$P_{tot}$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$	62	W
Maximum Junction Temperature	$T_j\max$		150	$^\circ\text{C}$
<b>Inverter Transistor</b>				
Collector-emitter break down voltage	$V_{CE}$		1200	V
DC collector current	$I_C$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$	52	A
Repetitive peak collector current	$I_{Cpulse}$	$t_p$ limited by $T_j\max$	225	A
Power dissipation per IGBT	$P_{tot}$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$	105	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{sc}$ $V_{CC}$	$T_j=150^\circ\text{C}$ $V_{GE}=15\text{V}$	10 800	$\mu\text{s}$ V
Maximum Junction Temperature	$T_j\max$		175	$^\circ\text{C}$

## Maximum Ratings

$T_j=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Inverter Diode</b>				
Repetitive peak reverse voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$	47	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_j\max$	225	A
Power dissipation per Diode	$P_{tot}$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$	77	W
Maximum Junction Temperature	$T_j\max$		175	°C
<b>Brake Transistor</b>				
Collector-emitter break down voltage	$V_{CE}$		1200	V
DC collector current	$I_C$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$	56	A
Repetitive peak collector current	$I_{Cpuls}$	$t_p$ limited by $T_j\max$	225	A
Power dissipation per IGBT	$P_{tot}$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$	120	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{sc}$ $V_{CC}$	$T_j=150^\circ\text{C}$ $V_{GE}=15\text{V}$	10 800	$\mu\text{s}$ V
Maximum Junction Temperature	$T_j\max$		175	°C
<b>Brake Diode</b>				
Repetitive peak reverse voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$	50	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_j\max$	225	A
Power dissipation per Diode	$P_{tot}$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$	86	W
Maximum Junction Temperature	$T_j\max$		175	°C
<b>Thermal Properties</b>				
Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{op}$		-40...+( $T_j\max - 25$ )	°C
<b>Insulation Properties</b>				
Insulation voltage	$V_{is}$	$t=2\text{s}$ DC voltage	4000	V
Creepage distance			min 12.7	mm
Clearance			min 12.7	mm

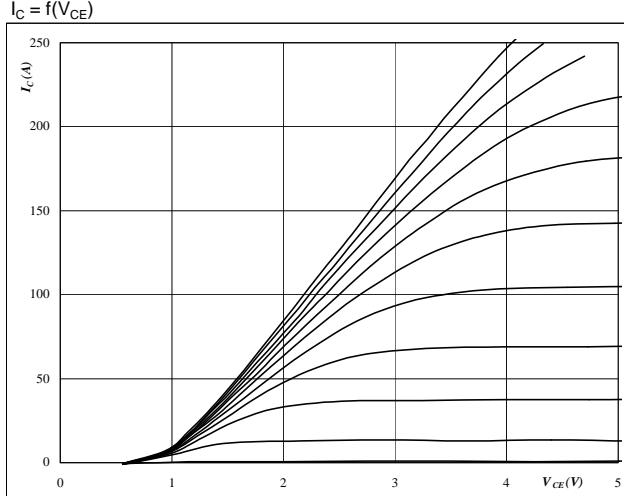


**Characteristic Values**

Parameter	Symbol	Conditions				Value			Unit	
		$V_{GE}$ [V] or $V_{GS}$ [V]	$V_T$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_C$ [A] or $I_F$ [A] or $I_D$ [A]	$T_J$	Min	Typ	Max		
<b>Brake Transistor</b>										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,003	$T_J=25^\circ C$ $T_J=150^\circ C$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		75	$T_J=25^\circ C$ $T_J=150^\circ C$	1,6	1,97 2,42	2,4	V
Collector-emitter cut-off incl diode	$I_{CES}$		0	1200		$T_J=25^\circ C$ $T_J=150^\circ C$			0,1	mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_J=25^\circ C$ $T_J=150^\circ C$			600	nA
Integrated Gate resistor	$R_{gint}$							10		$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff}=4\Omega$ $R_{gon}=4\Omega$	$\pm 15$	600	75	$T_J=25^\circ C$ $T_J=150^\circ C$		173 192		ns
Rise time	$t_r$					$T_J=25^\circ C$ $T_J=150^\circ C$		39 47		
Turn-off delay time	$t_{d(off)}$					$T_J=25^\circ C$ $T_J=150^\circ C$		280 360		
Fall time	$t_f$					$T_J=25^\circ C$ $T_J=150^\circ C$		74 116		
Turn-on energy loss per pulse	$E_{on}$					$T_J=25^\circ C$ $T_J=150^\circ C$		7,73 11,98		mWs
Turn-off energy loss per pulse	$E_{off}$					$T_J=25^\circ C$ $T_J=150^\circ C$		4,18 6,56		
Input capacitance	$C_{ies}$	$f=1MHz$	$0$	25		$T_J=25^\circ C$		4400		pF
Output capacitance	$C_{oss}$							290		
Reverse transfer capacitance	$C_{rss}$							235		
Gate charge	$Q_{Gate}$		$\pm 15$			$T_J=25^\circ C$		570		nC
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness $\leq 50\mu m$ $\lambda=1W/mK$						0,79		K/W
Thermal resistance chip to case per chip	$R_{thJC}$							N/A		
<b>Brake Diode</b>										
Diode forward voltage	$V_F$				75	$T_J=25^\circ C$ $T_J=150^\circ C$	1,5	2,01 2,04	2,8	V
Reverse leakage current	$I_r$			1200		$T_J=25^\circ C$ $T_J=150^\circ C$			120 8200	$\mu A$
Peak reverse recovery current	$I_{RRM}$	$R_{gon}=4\Omega$	$\pm 15$	600	75	$T_J=25^\circ C$ $T_J=150^\circ C$		35,5 48,2		A
Reverse recovery time	$t_{rr}$					$T_J=25^\circ C$ $T_J=150^\circ C$		443 670		ns
Reverse recovered charge	$Q_{rr}$					$T_J=25^\circ C$ $T_J=150^\circ C$		6,19 14,5		$\mu C$
Peak rate of fall of recovery current	$d(i_{rec})/dt$ max					$T_J=25^\circ C$ $T_J=150^\circ C$		156 74		$A/\mu s$
Reverse recovery energy	$E_{rec}$					$T_J=25^\circ C$ $T_J=150^\circ C$		2,22 5,36		mWs
Thermal resistance chip to heatsink per chip	$R_{thJH}$							1,11		K/W
Thermal resistance chip to case per chip	$R_{thJC}$							N/A		
<b>Thermistor</b>										
Rated resistance	$R$					$T=25^\circ C$		1000		$\Omega$
Deviation of R100	$\Delta R/R$	$R100=1670 \Omega$				$T=100^\circ C$	-3		3	%
R100	P					$T=100^\circ C$		1670,313		$\Omega$
Power dissipation constant						$T=25^\circ C$				mW/K
A-value	B(25/50)	Tol. %				$T=25^\circ C$		7,635*10-3		1/K
B-value	B(25/100)	Tol. %				$T=25^\circ C$		1,731*10-5		1/K <sup>2</sup>
Vincotech NTC Reference									E	

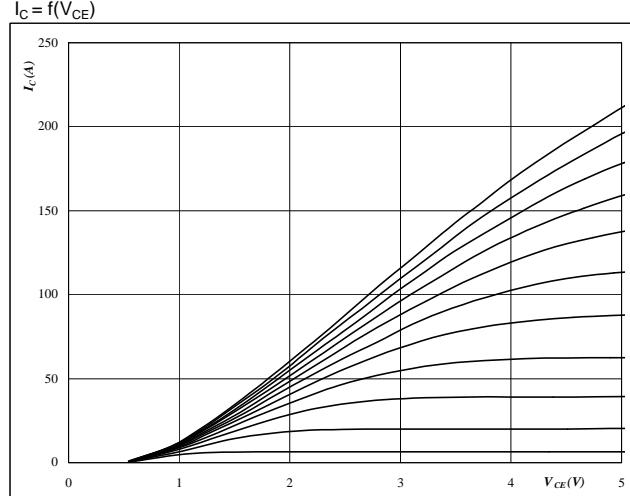
## Output Inverter

**Figure 1**  
Typical output characteristics  
 $I_C = f(V_{CE})$



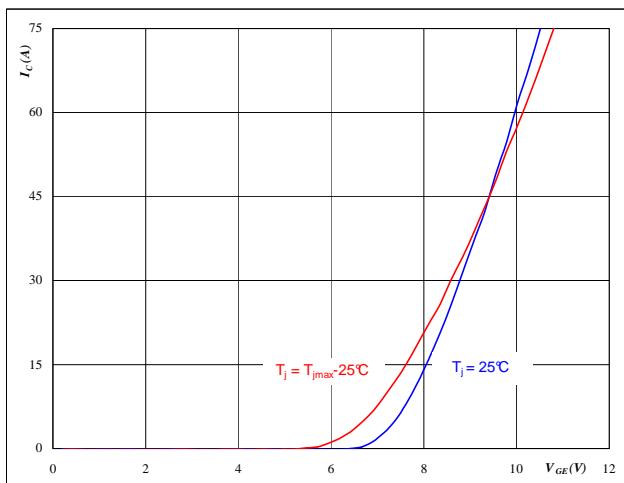
**At**  
 $t_p = 250 \mu s$   
 $T_j = 25^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 2**  
Typical output characteristics  
 $I_C = f(V_{CE})$



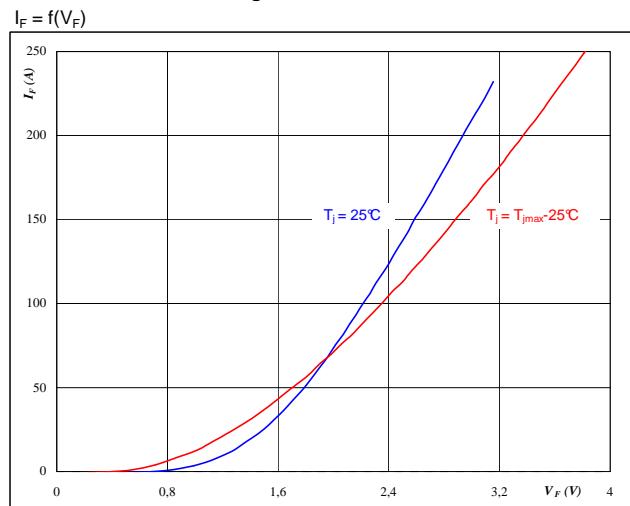
**At**  
 $t_p = 250 \mu s$   
 $T_j = 150^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 3**  
Typical transfer characteristics  
 $I_C = f(V_{GE})$



**At**  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 V$

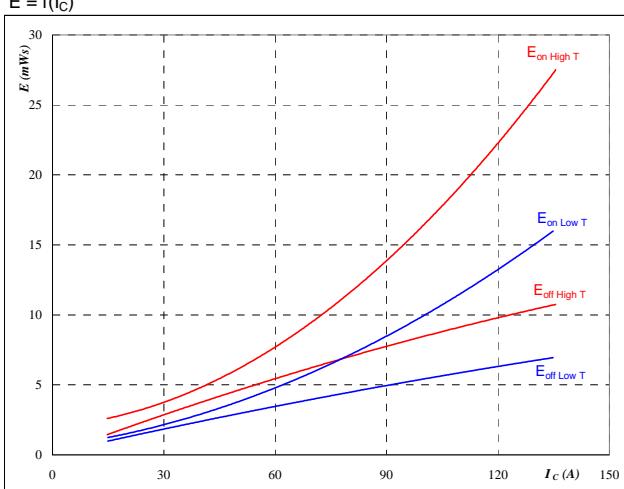
**Figure 4**  
Typical diode forward current as a function of forward voltage  
 $I_F = f(V_F)$



**At**  
 $t_p = 250 \mu s$

## Output Inverter

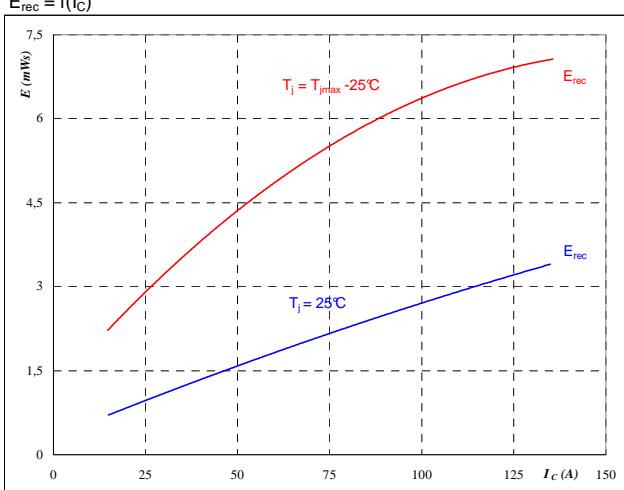
**Figure 5**  
Typical switching energy losses  
as a function of collector current  
 $E = f(I_C)$



With an inductive load at

T<sub>j</sub> = 25/150 °C  
 V<sub>CE</sub> = 600 V  
 V<sub>GE</sub> = ±15 V  
 R<sub>gon</sub> = 4 Ω  
 R<sub>goff</sub> = 4 Ω

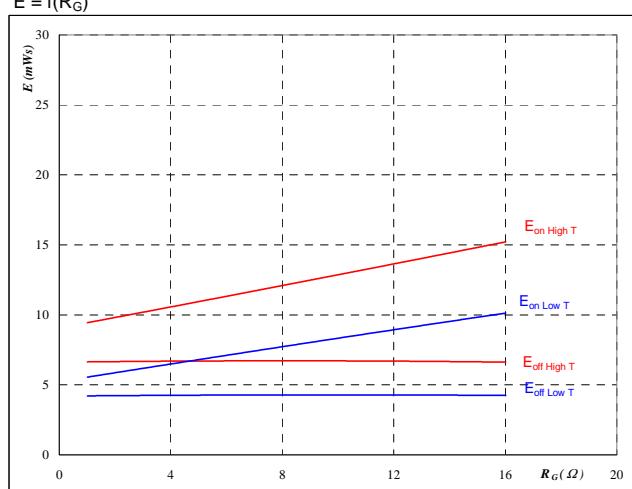
**Figure 7**  
Typical reverse recovery energy loss  
as a function of collector current  
 $E_{rec} = f(I_C)$



With an inductive load at

T<sub>j</sub> = 25/150 °C  
 V<sub>CE</sub> = 600 V  
 V<sub>GE</sub> = ±15 V  
 R<sub>gon</sub> = 4 Ω

**Figure 6**  
Typical switching energy losses  
as a function of gate resistor  
 $E = f(R_G)$

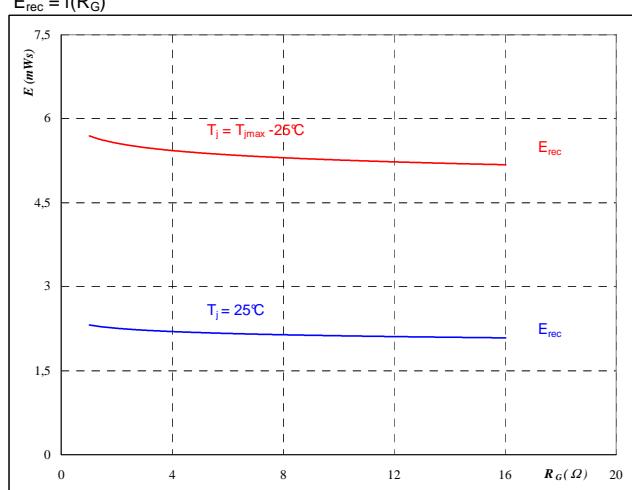


With an inductive load at

T<sub>j</sub> = 25/150 °C  
 V<sub>CE</sub> = 600 V  
 V<sub>GE</sub> = ±15 V  
 I<sub>C</sub> = 75 A

**Figure 7**  
Typical reverse recovery energy loss  
as a function of collector current  
 $E_{rec} = f(I_C)$

**Figure 8**  
Typical reverse recovery energy loss  
as a function of gate resistor  
 $E_{rec} = f(R_G)$



With an inductive load at

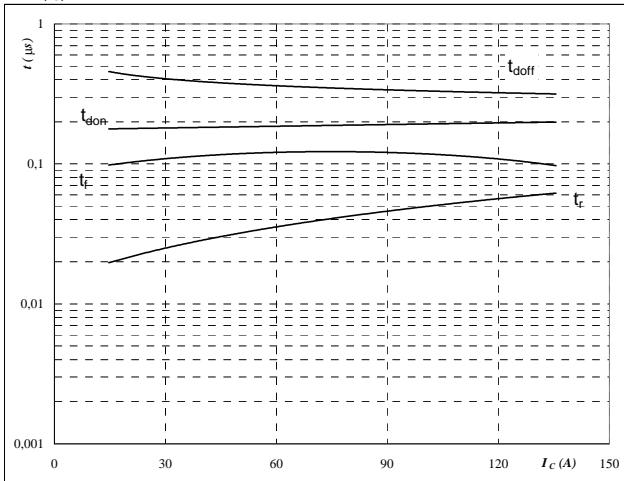
T<sub>j</sub> = 25/150 °C  
 V<sub>CE</sub> = 600 V  
 V<sub>GE</sub> = ±15 V  
 I<sub>C</sub> = 75 A

## Output Inverter

**Figure 9**

Typical switching times as a function of collector current

$$t = f(I_C)$$



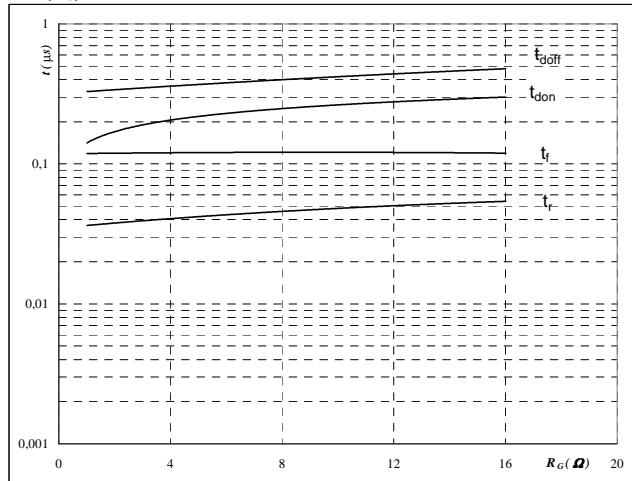
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	$\pm 15$	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

**Output inverter IGBT**
**Figure 10**

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



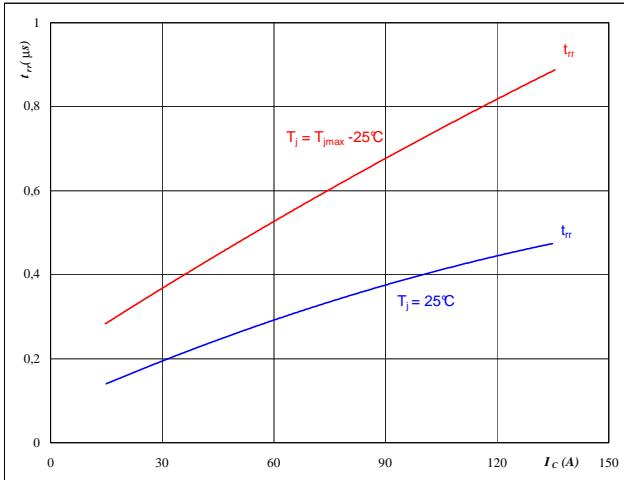
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	$\pm 15$	V
$I_C =$	75	A

**Figure 11**
**Output inverter FRED**

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



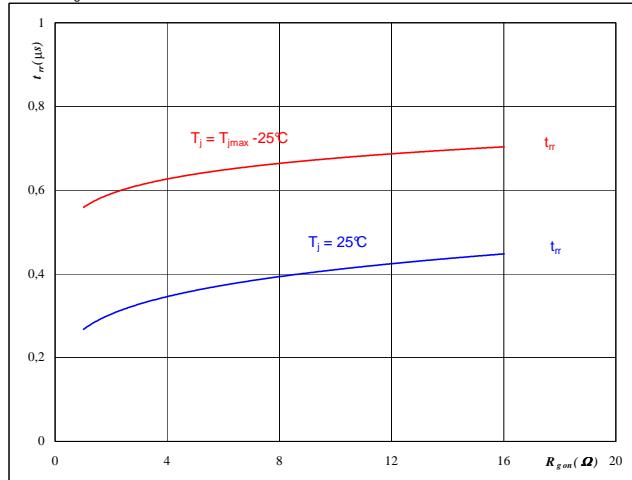
At

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	$\pm 15$	V
$R_{gon} =$	4	Ω

**Figure 12**
**Output inverter FRED**

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At

$T_j =$	25/150	°C
$V_R =$	600	V
$I_F =$	75	A
$V_{GE} =$	$\pm 15$	V

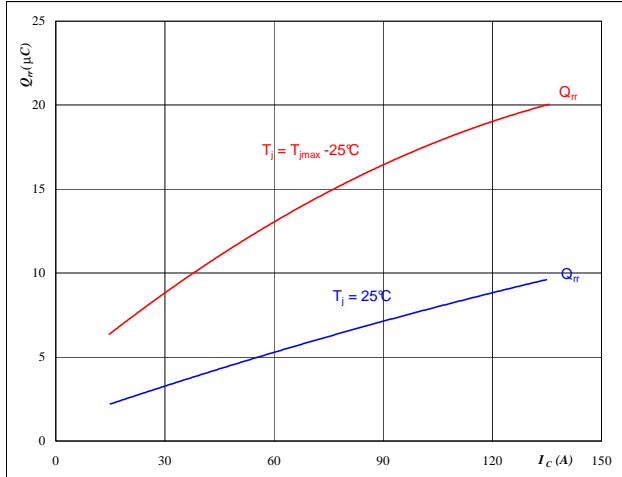
## Output Inverter

**Figure 13**

Output inverter FRED

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_C)$$


**At**

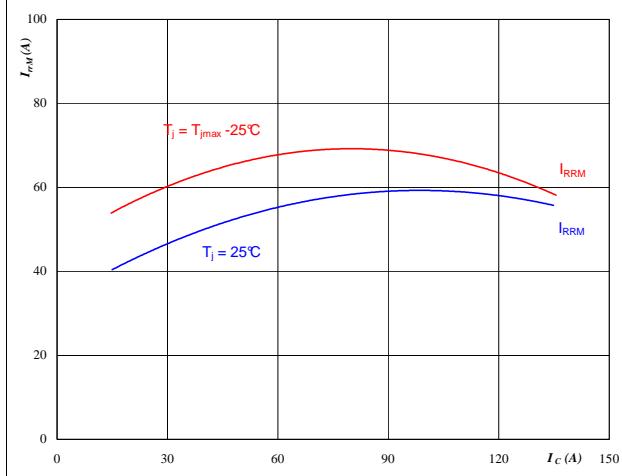
$$\begin{aligned} T_j &= \color{blue}{25/150} \quad \text{°C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 4 \quad \Omega \end{aligned}$$

**Figure 15**

Output inverter FRED

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_C)$$


**At**

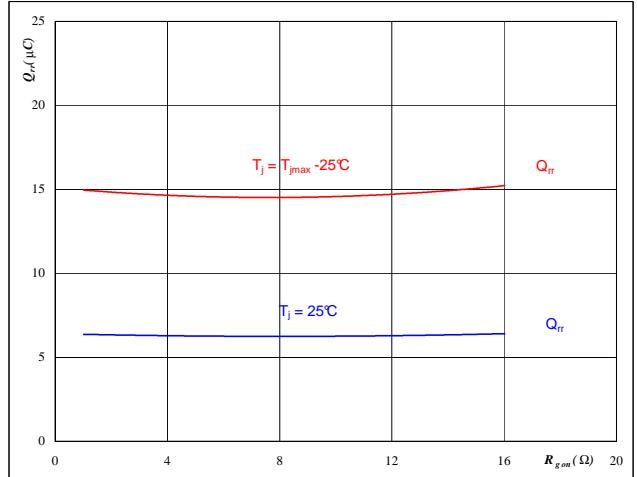
$$\begin{aligned} T_j &= \color{blue}{25/150} \quad \text{°C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 4 \quad \Omega \end{aligned}$$

**Figure 14**

Output inverter FRED

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$


**At**

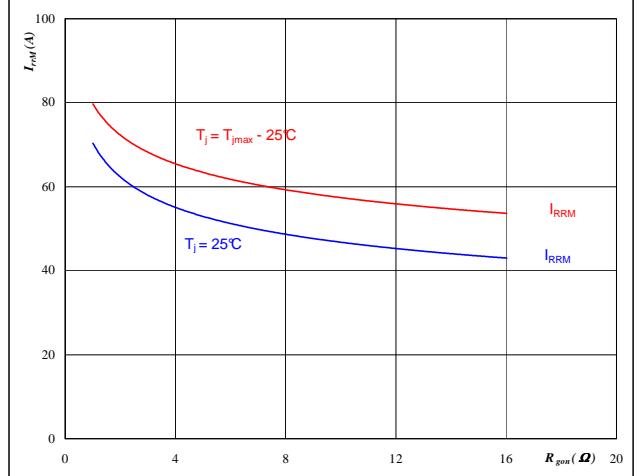
$$\begin{aligned} T_j &= \color{blue}{25/150} \quad \text{°C} \\ V_R &= 600 \quad \text{V} \\ I_F &= 75 \quad \text{A} \\ V_{GE} &= \pm 15 \quad \text{V} \end{aligned}$$

**Figure 16**

Output inverter FRED

Typical reverse recovery current as a function of IGBT turn on gate resistor

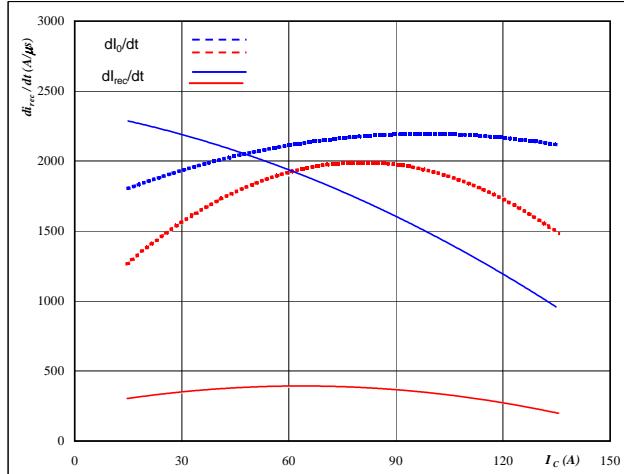
$$I_{RRM} = f(R_{gon})$$


**At**

$$\begin{aligned} T_j &= \color{blue}{25/150} \quad \text{°C} \\ V_R &= 600 \quad \text{V} \\ I_F &= 75 \quad \text{A} \\ V_{GE} &= \pm 15 \quad \text{V} \end{aligned}$$

## Output Inverter

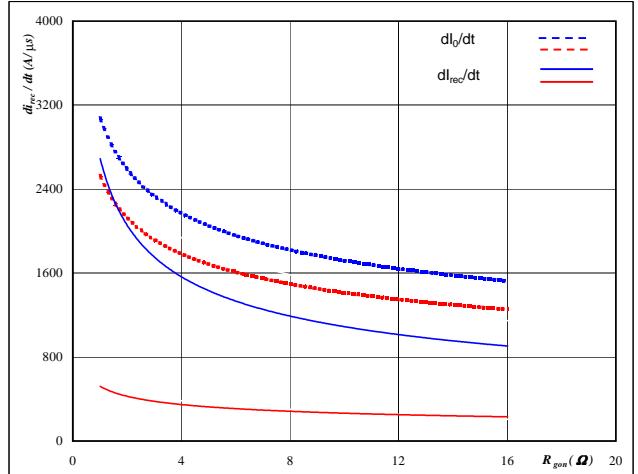
**Figure 17**  
Typical rate of fall of forward  
and reverse recovery current as a  
function of collector current  
 $dI_0/dt, dI_{rec}/dt = f(I_C)$



**At**  
 $T_j = 25/150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 4 \Omega$

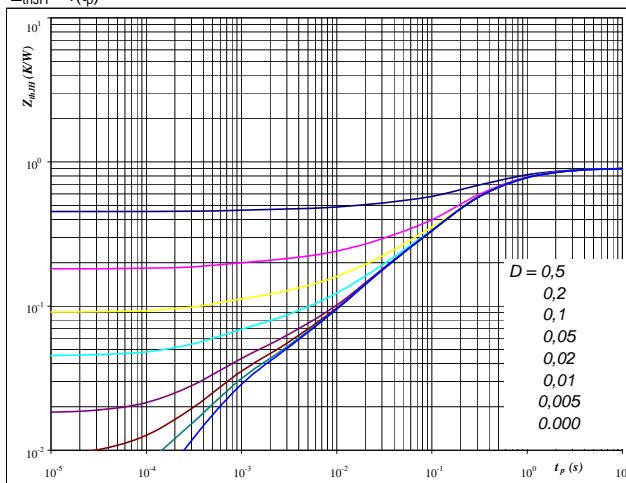
Output inverter FRED

**Figure 18**  
Typical rate of fall of forward  
and reverse recovery current as a  
function of IGBT turn on gate resistor  
 $dI_0/dt, dI_{rec}/dt = f(R_{gon})$



**At**  
 $T_j = 25/150 \text{ } ^\circ\text{C}$   
 $V_R = 600 \text{ V}$   
 $I_F = 75 \text{ A}$   
 $V_{GE} = \pm 15 \text{ V}$

**Figure 19**  
IGBT transient thermal impedance  
as a function of pulse width  
 $Z_{thJH} = f(t_p)$

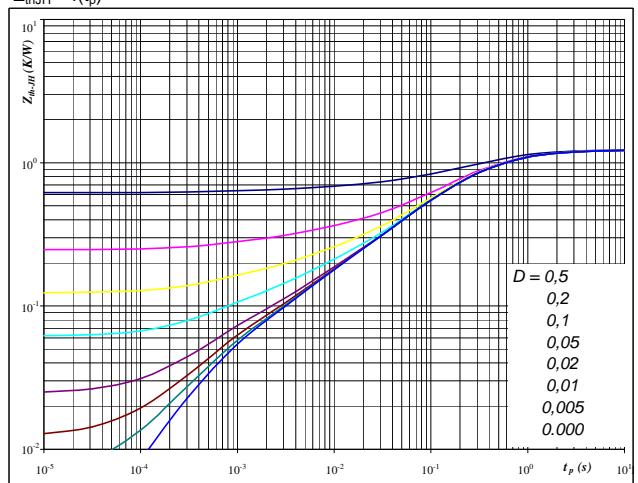


**At**  
 $D = t_p / T$   
 $R_{thJH} = 0.91 \text{ K/W}$

IGBT thermal model values

R (C/W)	Tau (s)
0,07	4,1E+00
0,35	6,1E-01
0,38	1,7E-01
0,08	1,5E-02
0,03	7,7E-04

**Figure 20**  
FRED transient thermal impedance  
as a function of pulse width  
 $Z_{thJH} = f(t_p)$



**At**  
 $D = t_p / T$   
 $R_{thJH} = 1,24 \text{ K/W}$

FRED thermal model values

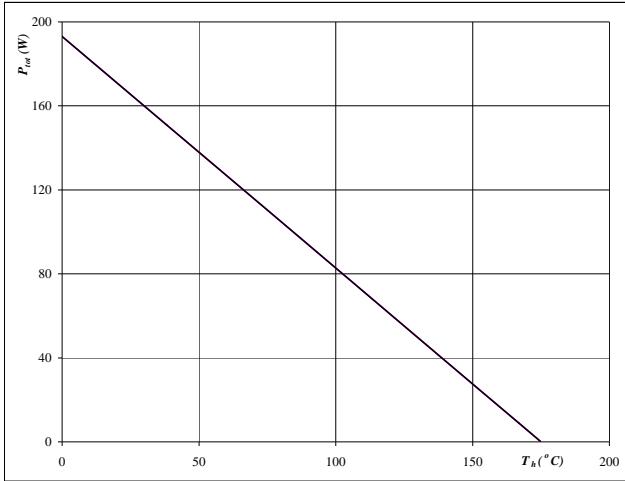
R (C/W)	Tau (s)
0,04	9,7E+00
0,24	1,1E+00
0,64	2,3E-01
0,20	4,2E-02
0,08	5,3E-03
0,04	6,3E-04

## Output Inverter

**Figure 21**

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

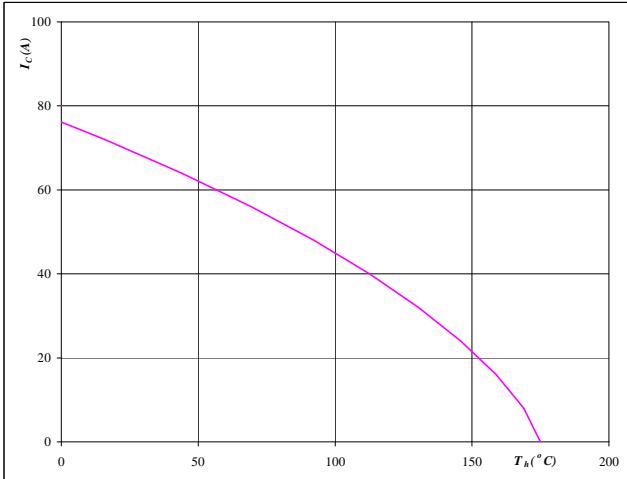

**At**

$$T_j = 175 \quad ^\circ\text{C}$$

**Output inverter IGBT**
**Figure 22**

**Collector current as a function of heatsink temperature**

$$I_C = f(T_h)$$


**At**

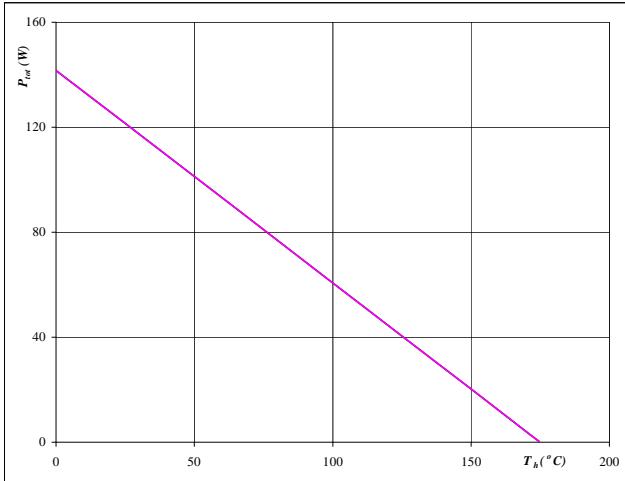
$$T_j = 175 \quad ^\circ\text{C}$$

$$V_{GE} = 15 \quad \text{V}$$

**Figure 23**

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

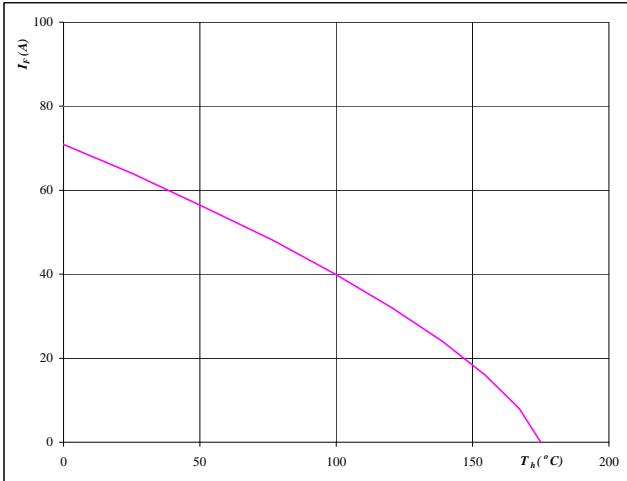

**At**

$$T_j = 175 \quad ^\circ\text{C}$$

**Output inverter IGBT**
**Figure 24**

**Forward current as a function of heatsink temperature**

$$I_F = f(T_h)$$


**At**

$$T_j = 175 \quad ^\circ\text{C}$$

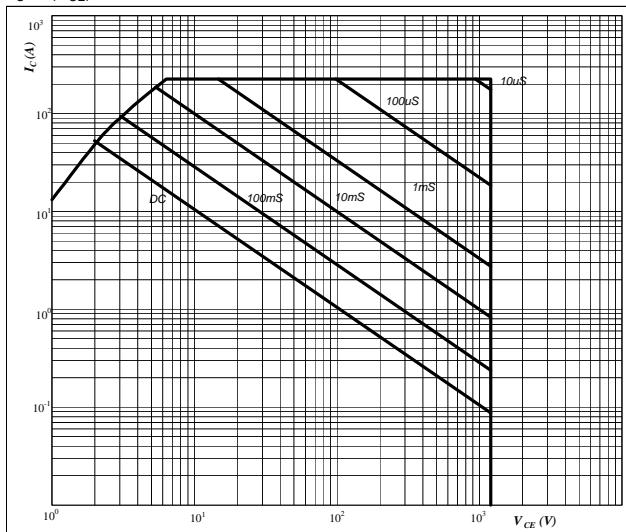
**Output inverter FRED**

## Output Inverter

**Figure 25**

**Safe operating area as a function  
of collector-emitter voltage**

$$I_C = f(V_{CE})$$


**At**

D = single pulse

T<sub>h</sub> = 80 °C

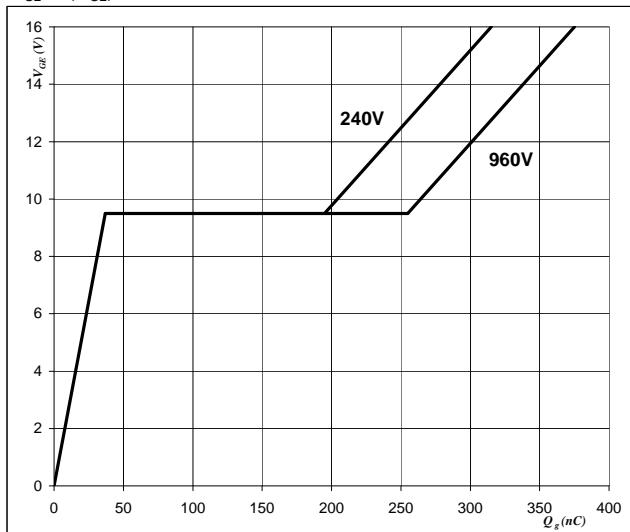
V<sub>GE</sub> = ±15 V

T<sub>j</sub> = T<sub>jmax</sub> °C

**Output inverter IGBT**
**Figure 26**

**Gate voltage vs Gate charge**

$$V_{GE} = f(Q_{GE})$$

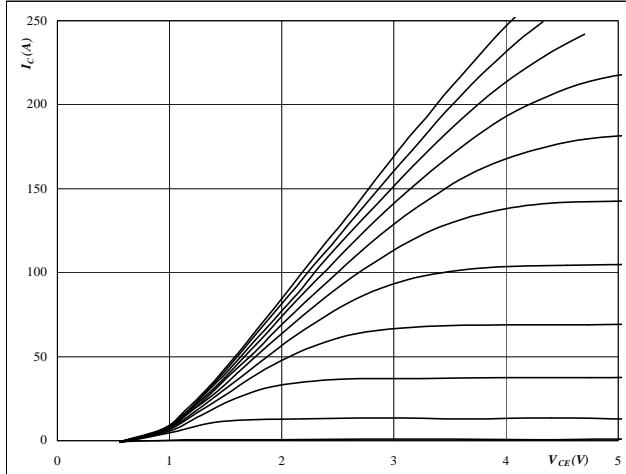

**At**

I<sub>C</sub> = 75 A

## Brake

**Figure 1**
**Typical output characteristics**

$$I_C = f(V_{CE})$$


**At**

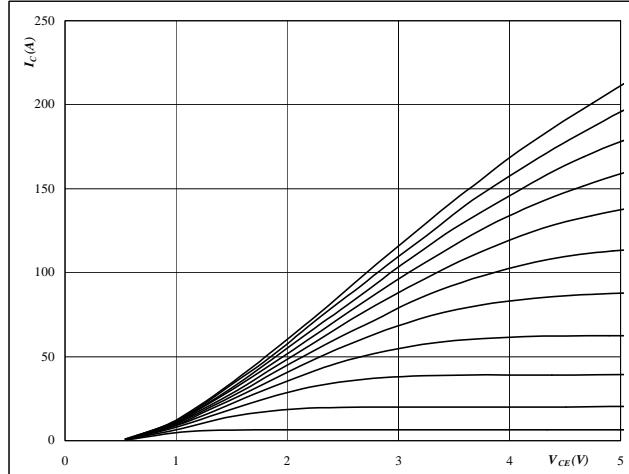
$$t_p = 250 \mu\text{s}$$

$$T_j = 25^\circ\text{C}$$

 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Brake IGBT**
**Figure 2**
**Typical output characteristics**

$$I_C = f(V_{CE})$$


**At**

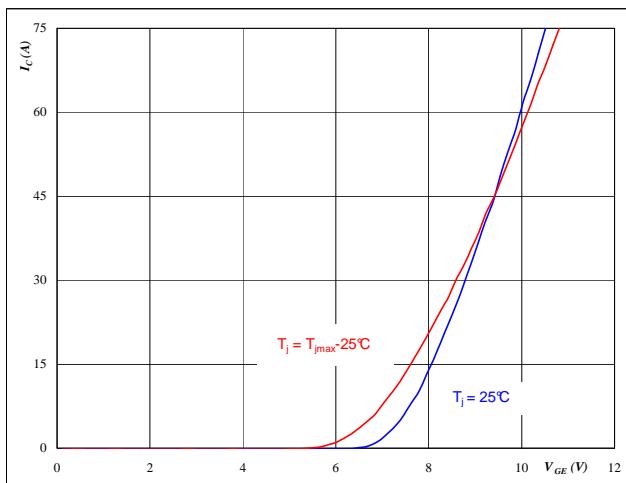
$$t_p = 250 \mu\text{s}$$

$$T_j = 151^\circ\text{C}$$

 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 3**
**Brake IGBT**
**Typical transfer characteristics**

$$I_C = f(V_{GE})$$

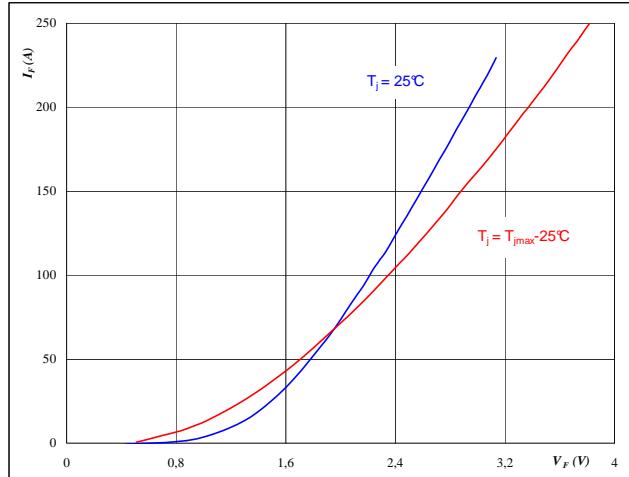

**At**

$$t_p = 250 \mu\text{s}$$

$$V_{CE} = 10 \text{ V}$$

**Figure 4**
**Brake FRED**
**Typical diode forward current as**
**a function of forward voltage**

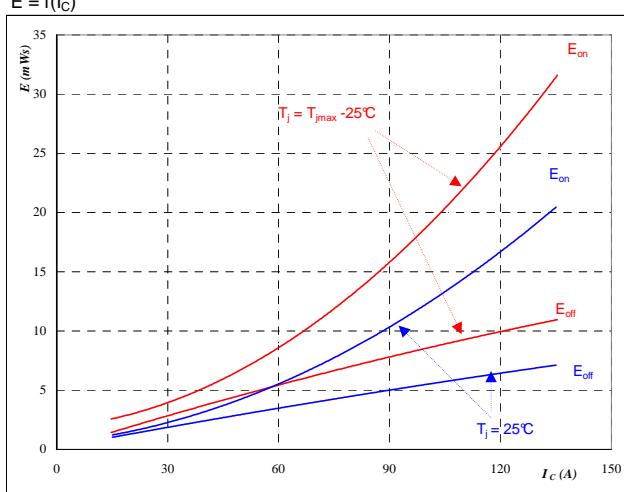
$$I_F = f(V_F)$$


**At**

$$t_p = 250 \mu\text{s}$$

## Brake

**Figure 5**  
Typical switching energy losses  
as a function of collector current  
 $E = f(I_C)$

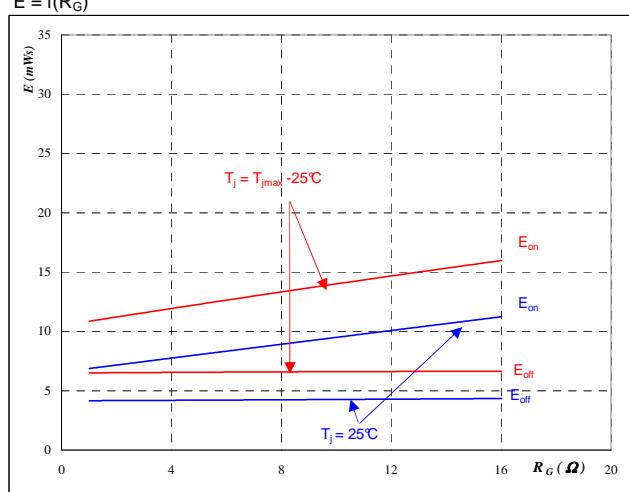


With an inductive load at

$$\begin{aligned}T_j &= \textcolor{red}{25/150} \quad ^\circ\text{C} \\V_{CE} &= 600 \quad \text{V} \\V_{GE} &= \pm 15 \quad \text{V} \\R_{gon} &= 4 \quad \Omega \\R_{goff} &= 4 \quad \Omega\end{aligned}$$

Brake IGBT

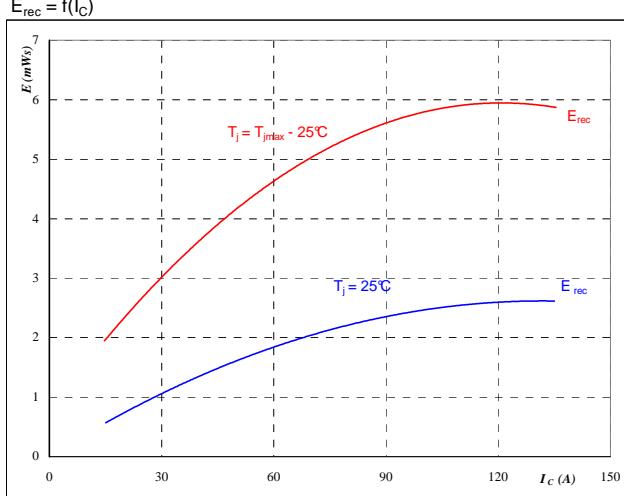
**Figure 6**  
Typical switching energy losses  
as a function of gate resistor  
 $E = f(R_G)$



With an inductive load at

$$\begin{aligned}T_j &= \textcolor{red}{25/150} \quad ^\circ\text{C} \\V_{CE} &= 600 \quad \text{V} \\V_{GE} &= \pm 15 \quad \text{V} \\I_C &= 75 \quad \text{A}\end{aligned}$$

**Figure 7**  
Typical reverse recovery energy loss  
as a function of collector current  
 $E_{rec} = f(I_C)$

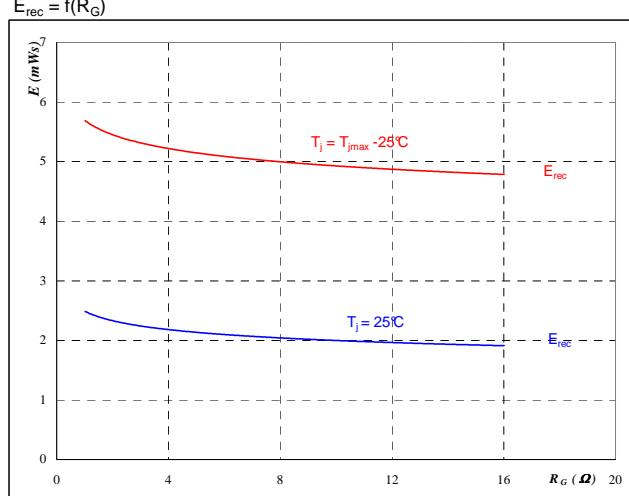


With an inductive load at

$$\begin{aligned}T_j &= \textcolor{red}{25/150} \quad ^\circ\text{C} \\V_{CE} &= 600 \quad \text{V} \\V_{GE} &= \pm 15 \quad \text{V} \\R_{gon} &= 4 \quad \Omega\end{aligned}$$

Brake IGBT

**Figure 8**  
Typical reverse recovery energy loss  
as a function of gate resistor  
 $E_{rec} = f(R_G)$



With an inductive load at

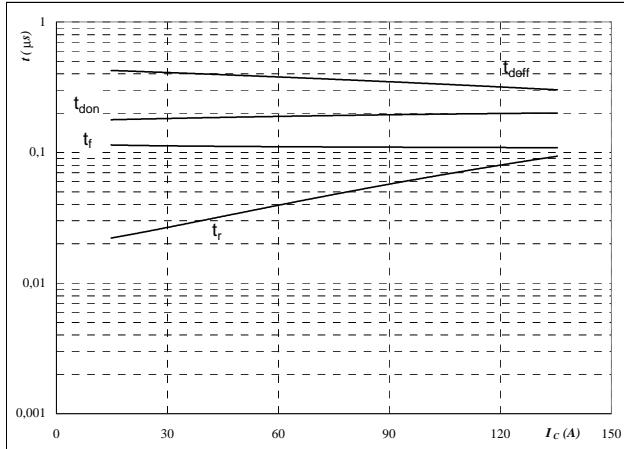
$$\begin{aligned}T_j &= \textcolor{red}{25/150} \quad ^\circ\text{C} \\V_{CE} &= 600 \quad \text{V} \\V_{GE} &= \pm 15 \quad \text{V} \\I_C &= 75 \quad \text{A}\end{aligned}$$

## Brake

**Figure 9**

Typical switching times as a function of collector current

$$t = f(I_C)$$



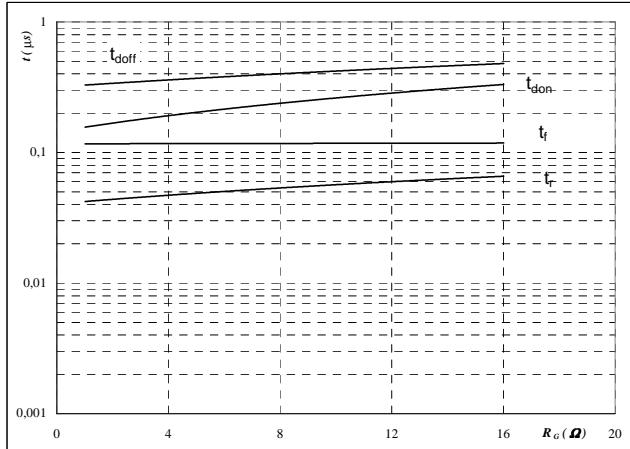
With an inductive load at

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

**Brake IGBT**
**Figure 10**

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



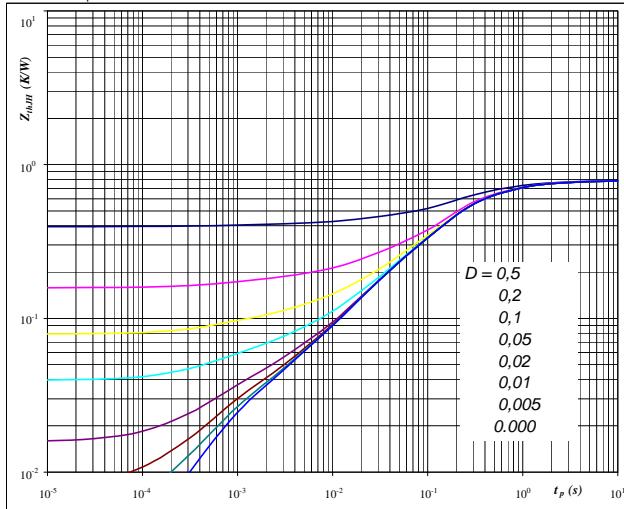
With an inductive load at

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	75	A

**Figure 11**

IGBT transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$



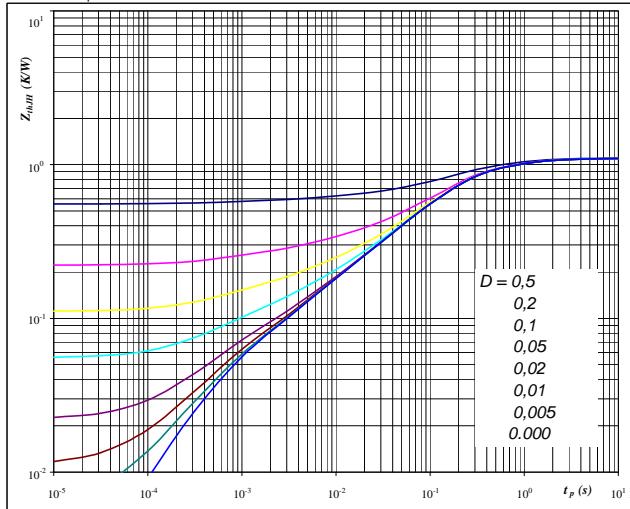
At

$$\begin{aligned} D &= t_p / T \\ R_{thJH} &= 0.79 \quad \text{K/W} \end{aligned}$$

**Brake IGBT**
**Figure 12**

FRED transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$

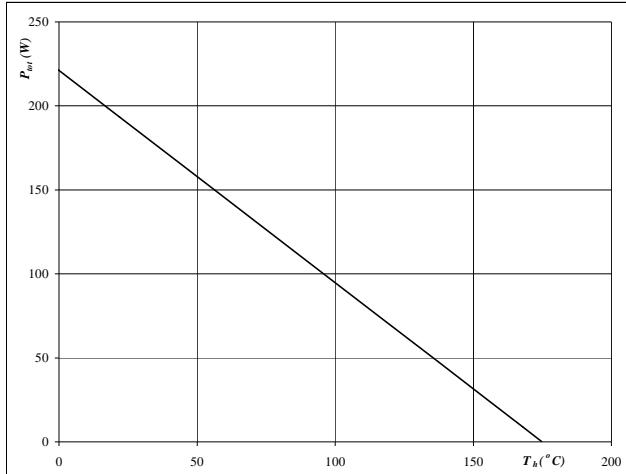


At

$$\begin{aligned} D &= t_p / T \\ R_{thJH} &= 1.11 \quad \text{K/W} \end{aligned}$$

## Brake

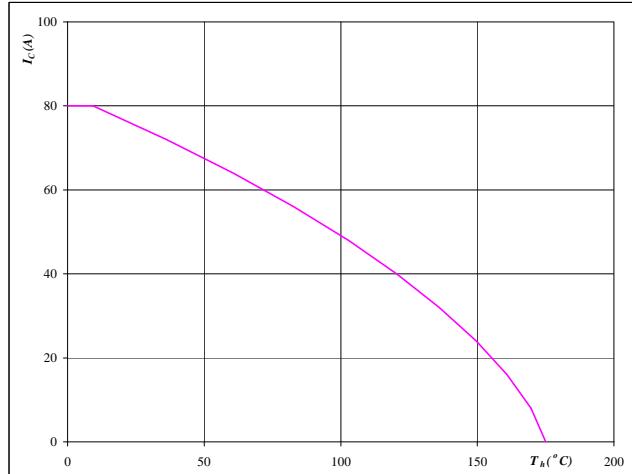
**Figure 13**  
**Power dissipation as a function of heatsink temperature**  
 $P_{\text{tot}} = f(T_h)$



At  
 $T_j = 175$  °C

Brake IGBT

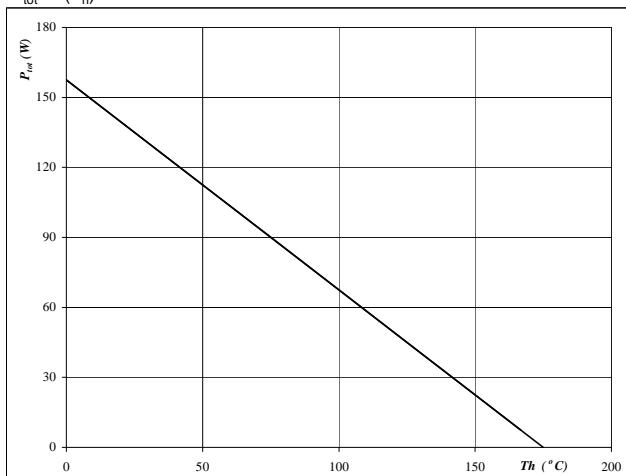
**Figure 14**  
**Collector current as a function of heatsink temperature**  
 $I_C = f(T_h)$



At  
 $T_j = 175$  °C  
 $V_{GE} = 15$  V

Brake IGBT

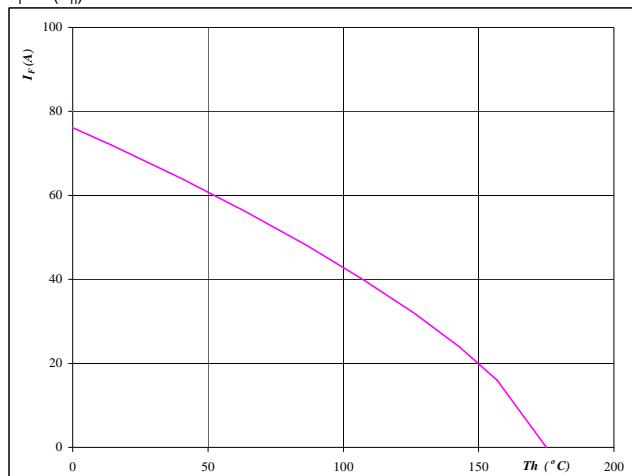
**Figure 15**  
**Power dissipation as a function of heatsink temperature**  
 $P_{\text{tot}} = f(T_h)$



At  
 $T_j = 175$  °C

Brake FRED

**Figure 16**  
**Forward current as a function of heatsink temperature**  
 $I_F = f(T_h)$



At  
 $T_j = 175$  °C

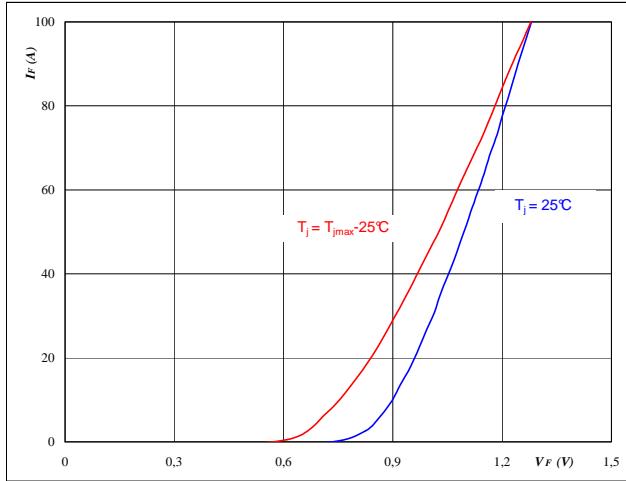
Brake FRED

## Input Rectifier Bridge

**Figure 1**

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$

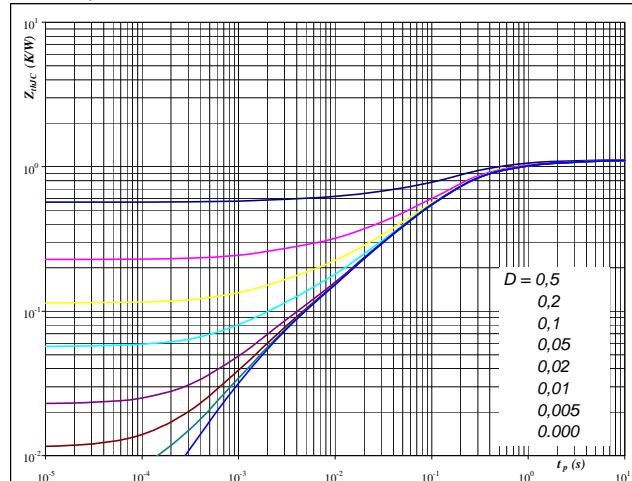

**At**

$$t_p = 250 \mu\text{s}$$

**Rectifier diode**
**Figure 2**

Diode transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$


**At**

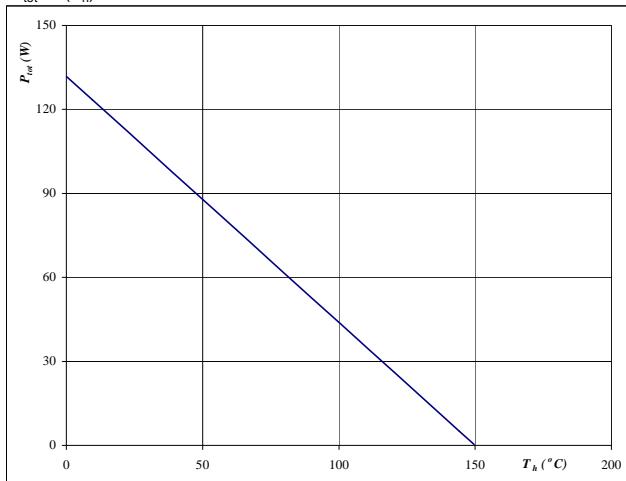
$$D = t_p / T$$

$$R_{thJH} = 1,138 \text{ K/W}$$

**Rectifier diode**
**Figure 3**

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$

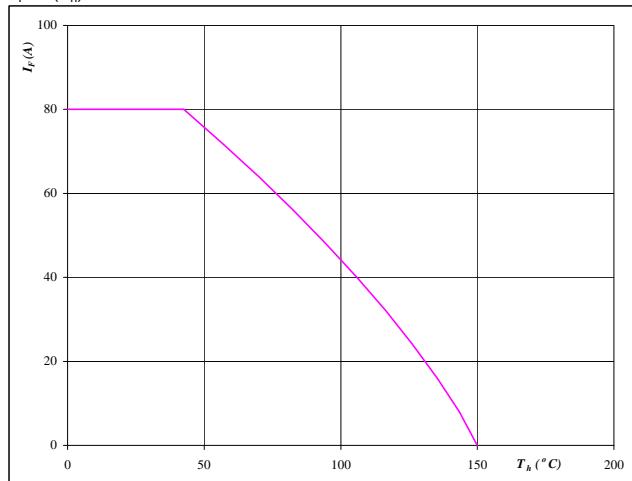

**At**

$$T_j = 150 \text{ °C}$$

**Rectifier diode**
**Figure 4**

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$


**At**

$$T_j = 150 \text{ °C}$$

**Rectifier diode**

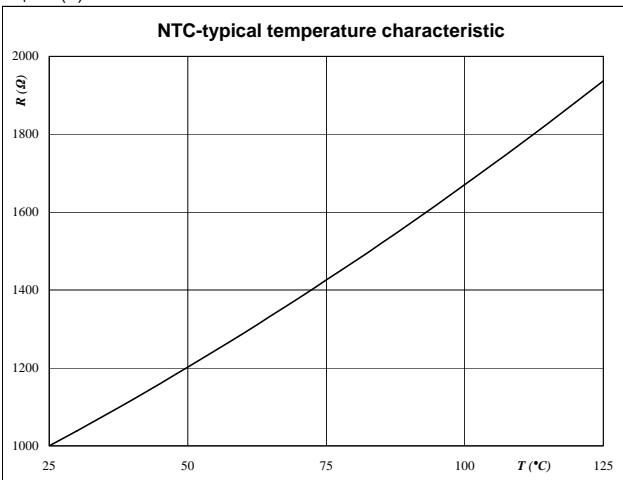
## Thermistor

**Figure 1**

Thermistor

Typical NTC characteristic  
as a function of temperature

$$R_T = f(T)$$



## Switching Definitions Output Inverter

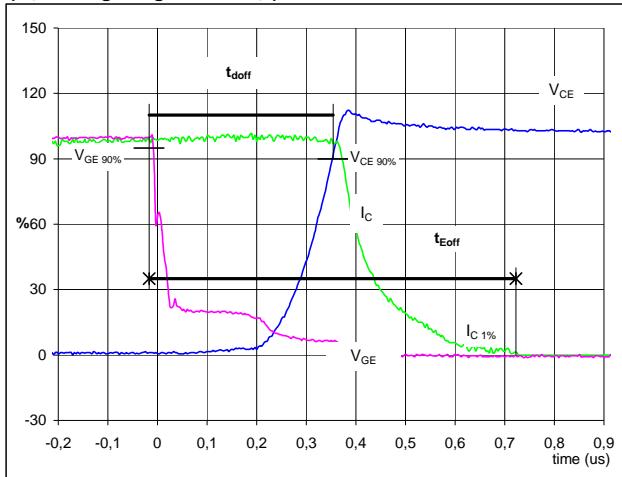
### General conditions

$T_j$	= 150 °C
$R_{gon}$	= 4 Ω
$R_{goff}$	= 4 Ω

**Figure 1**

Output inverter IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$   
 $(t_{Eoff} = \text{integrating time for } E_{off})$

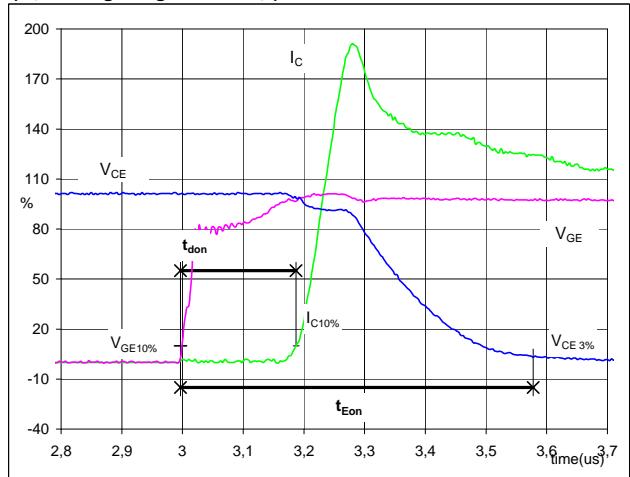


$V_{GE}(0\%) = -15$  V  
 $V_{GE}(100\%) = 15$  V  
 $V_C(100\%) = 600$  V  
 $I_C(100\%) = 75$  A  
 $t_{doff} = 0,36$  μs  
 $t_{Eoff} = 0,74$  μs

**Figure 2**

Output inverter IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$   
 $(t_{Eon} = \text{integrating time for } E_{on})$

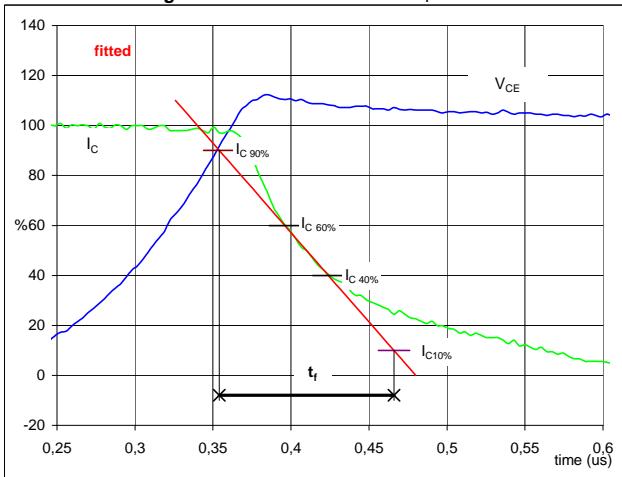


$V_{GE}(0\%) = -15$  V  
 $V_{GE}(100\%) = 15$  V  
 $V_C(100\%) = 600$  V  
 $I_C(100\%) = 75$  A  
 $t_{don} = 0,19$  μs  
 $t_{Eon} = 0,58$  μs

**Figure 3**

Output inverter IGBT

Turn-off Switching Waveforms & definition of  $t_f$

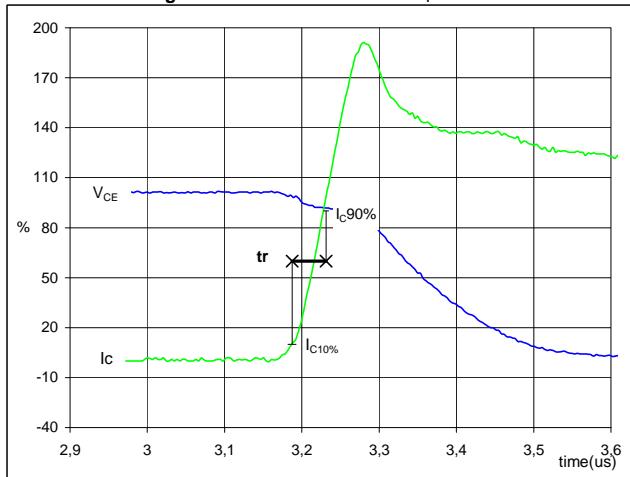


$V_C(100\%) = 600$  V  
 $I_C(100\%) = 75$  A  
 $t_f = 0,12$  μs

**Figure 4**

Output inverter IGBT

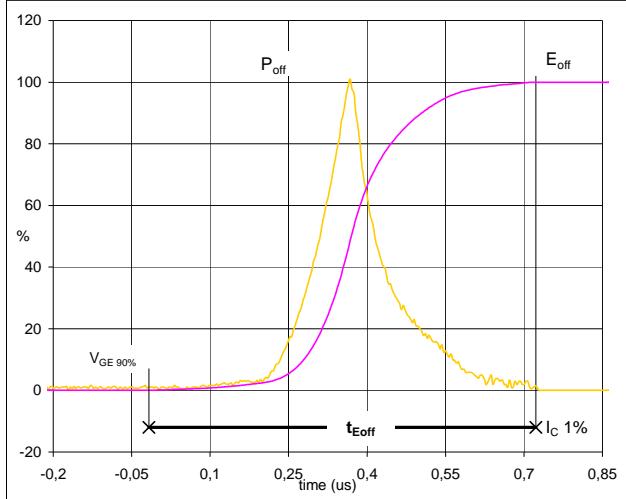
Turn-on Switching Waveforms & definition of  $t_r$



$V_C(100\%) = 600$  V  
 $I_C(100\%) = 75$  A  
 $t_r = 0,04$  μs

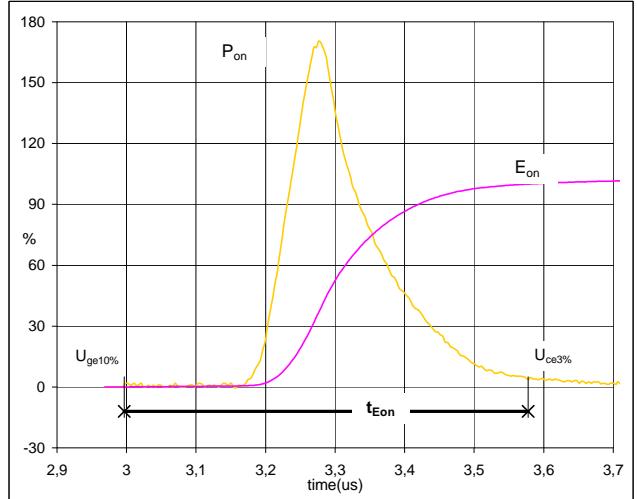
## Switching Definitions Output Inverter

**Figure 5** Output inverter IGBT  
**Turn-off Switching Waveforms & definition of  $t_{Eoff}$**



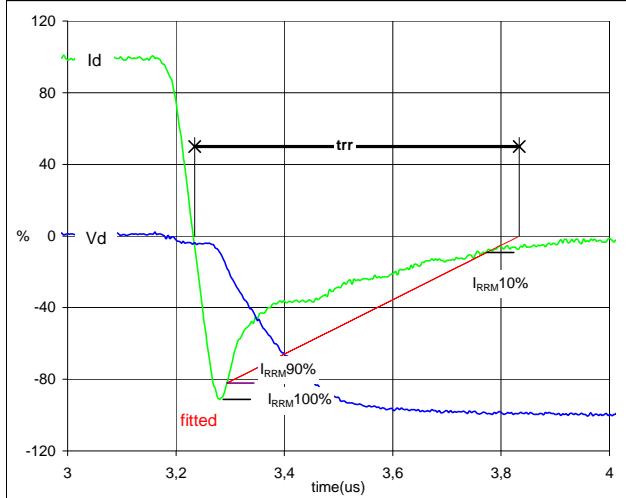
$P_{off} (100\%) = 45,10 \text{ kW}$   
 $E_{off} (100\%) = 6,68 \text{ mJ}$   
 $t_{Eoff} = 0,74 \mu\text{s}$

**Figure 6** Output inverter IGBT  
**Turn-on Switching Waveforms & definition of  $t_{Eon}$**



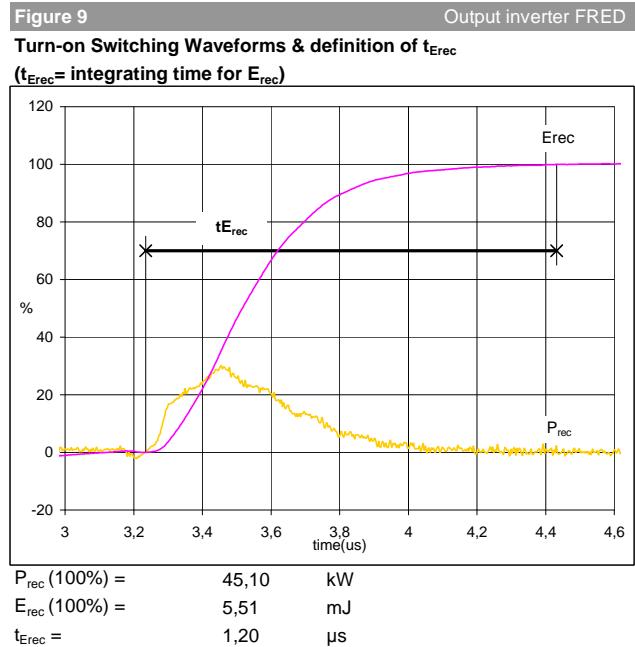
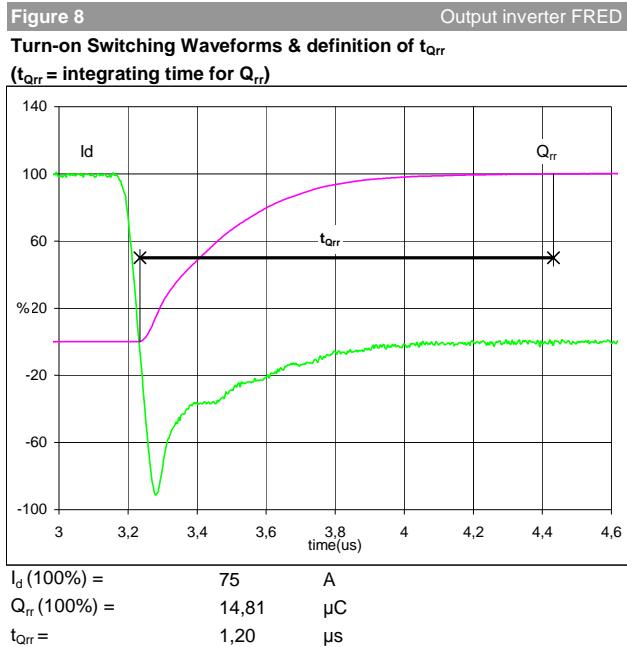
$P_{on} (100\%) = 45,10 \text{ kW}$   
 $E_{on} (100\%) = 10,61 \text{ mJ}$   
 $t_{Eon} = 0,58 \mu\text{s}$

**Figure 7** Output inverter IGBT  
**Turn-off Switching Waveforms & definition of  $t_{rr}$**



$V_d (100\%) = 600 \text{ V}$   
 $I_d (100\%) = 75 \text{ A}$   
 $I_{RRM} (100\%) = -68 \text{ A}$   
 $t_{rr} = 0,60 \mu\text{s}$

## Switching Definitions Output Inverter

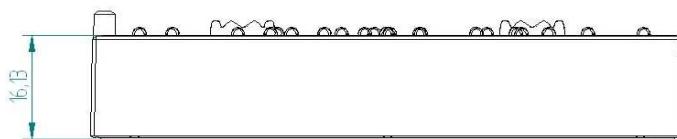
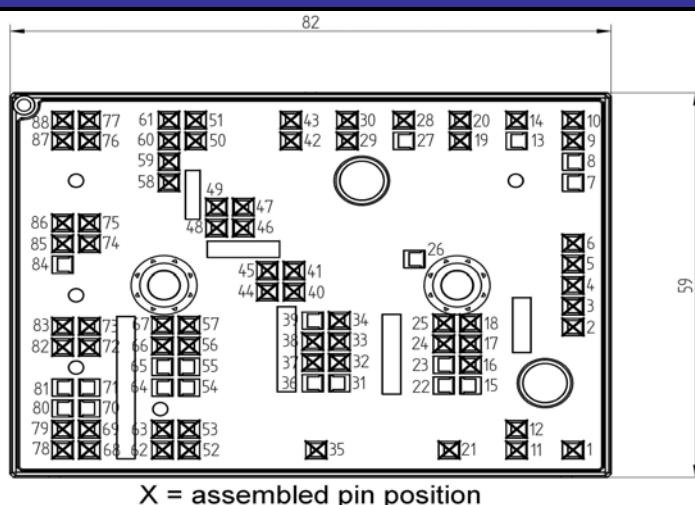


## Ordering Code and Marking - Outline - Pinout

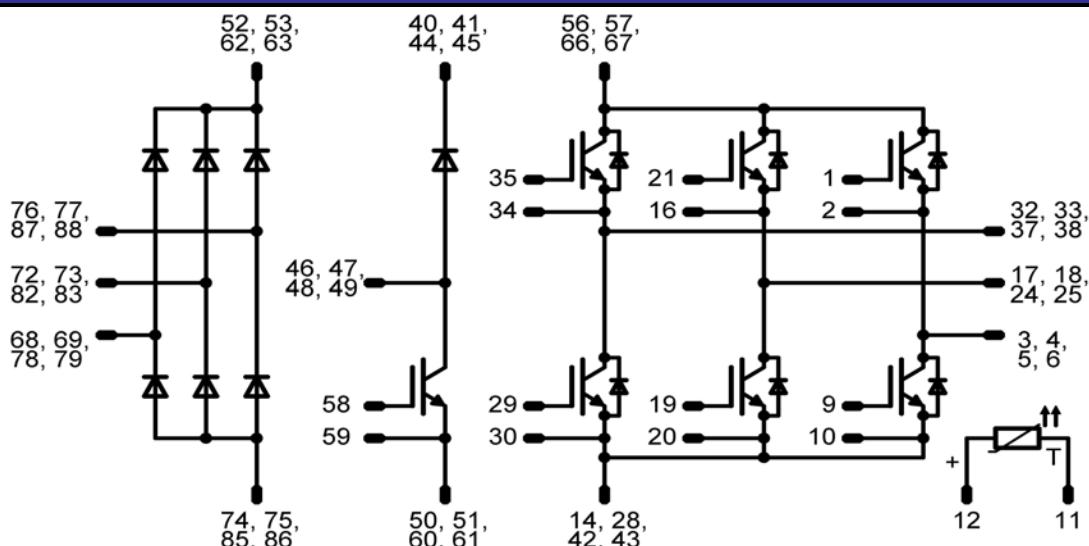
### Ordering Code & Marking

Version	Ordering Code	in DataMatrix as	in packaging barcode as
with std lid (black V23990-K12-T-PM)	V23990-K429-A40-/0A-/PM	K429A40	K429A40-/0A/
with std lid (black V23990-K12-T-PM) and P12	V23990-K429-A40-/1A-/PM	K429A40	K429A40-/1A/
with thin lid (white V23990-K13-T-PM)	V23990-K429-A40-/0B-/PM	K429A40	K429A40-/0B/
with thin lid (white V23990-K13-T-PM) and P12	V23990-K429-A40-/1B-/PM	K429A40	K429A40-/1B/

### Outline



### Pinout



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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.